MOSFET – P-Channel, QFET[®]

-200 V, -11.5 A, 470 mΩ

FQB12P20

General Description

These P-Channel enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters.

Features

- $-11.5 \text{ A}, -200 \text{ V}, \text{R}_{\text{DS(on)}} = 0.47 \Omega @ \text{V}_{\text{GS}} = -10 \text{ V}$
- Low Gate Charge (Typical 31 nC)
- Low Crss (typical 30 pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

			1	
Symbol	Parameter	FQB12P20	Unit	
V _{DSS}	Drain-Source Voltage	-200	V	
I _D	Drain Current – Continuous (T _C = 25° C)	-11.5	А	
	– Continuous (T _C = 100°C)	-7.27	А	
I _{DM}	Drain Current – Pulsed (Note 1)	-46	А	
V _{GSS}	Gate-Source Voltage	+30	V	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	810	mJ	
I _{AR}	Avalanche Current (Note 1)	-11.5	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)	12	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)	-5.5	V/ns	
PD	Power Dissipation ($T_A = 25^{\circ}C$) *	3.13	W	
	Power Dissipation (T _C = 25° C)	120	W	
	– Derate above 25°C	0.96	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range	–55 to +150	°C	
TL	Maximum lead temperature for soldering 300 purposes, 1/8" from case for 5 seconds			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

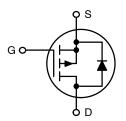
- *When mounted on the minimum pad size recommended (PCB Mount)
- 1. Repetitive Rating : Pulse width limited by maximum junction temperature
- 2. L = 9.2 mH, I_{AS} = -11.5 A, V_{DD} = -50 V, R_G = 25 Ω , Starting T_J = 25°C 3. I_{SD} ≤ -11.5 A, di/dt ≤ 300 A/µs, V_{DD} ≤ BV_{DSS} , Starting T_J = 25°C



ON Semiconductor®

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V _{DSS}	R _{DS(ON)} MAX	I _D MAX
–200 V	0.47 Ω @ –10 V	–11.5 A

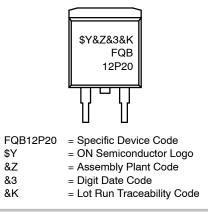


P-CHANNEL MOSFET



D²PAK-3 (TO-263, 3-LEAD) CASE 418AJ

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

THERMAL RESISTANCE MAXIMUM RATINGS

Symbol	Parameter	Тур	Мах	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	-	1.04	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *	-	40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	-	62.5	°C/W

*When mounted on the minimum pad size recommended (PCB Mount)

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
OFF CHARAC	CTERISTICS					
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I _D = -250 μ A	-200	-	-	V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C	-	-	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = -200 V, V_{GS} = 0 V	-	-	-1	μA
		$V_{DS} = -160 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	-	-10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = -30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = 30 V, V_{DS} = 0 V	-	-	100	nA
ON CHARAC	TERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \ I_D = -250 \ \mu A$	-3.0	-	-5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -5.75 A	-	0.36	0.47	Ω
9FS	Forward Transconductance	V _{DS} = -40 V, I _D = -5.75 A (Note 4)	-	6.4	-	S
DYNAMIC CH	IARACTERISTICS					
C _{iss}	Input Capacitance	V_{DS} = –25 V, V_{GS} = 0 V, f = 1.0 MHz	-	920	1200	pF
C _{oss}	Output Capacitance		-	190	250	pF
C _{rss}	Reverse Transfer Capacitance		_	30	40	pF
SWITCHING	CHARACTERISTICS				•	
t _{d(on)}	Turn-On Delay Time	V _{DD} = -100 V, I _D = -11.5 A,	-	20	50	ns
t _r	Turn–On Rise Time	R _G = 25 Ω (Note 4, 5)	-	195	400	ns
t _{d(off)}	Turn-Off Delay Time		-	40	90	ns
t _f	Turn-Off Fall Time		-	60	130	ns
Qg	Total Gate Charge	V _{DS} = -160 V, I _D = -11.5 A,	-	31	40	nC
Q _{as}	Gate-Source Charge	V _{GS} = -10 V (Note 4, 5)	-	8.1	-	nC

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUMUM RATINGS

۱ _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	-11.5	А
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		-	-	-46	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = -11.5 \text{ A}$	-	-	-5.0	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_S = -11.5 A,$	-	180	-	ns
Q _{rr}	Reverse Recovery Charge	dl _F / dt = 100 A/µs (Note 4)	-	1.44	_	μC

(Note 4, 5)

_

16

_

nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: Pulse width \leq 300 µs, Duty cycle \leq 2%

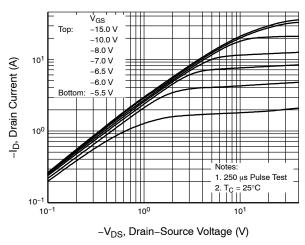
Gate-Drain Charge

 Q_{gs}

Qg_d

5. Essentially independent of operating temperature

TYPICAL CHARACTERISTICS





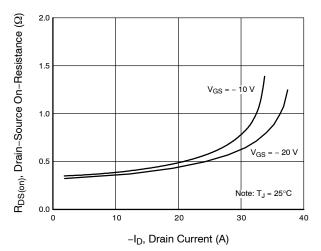


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

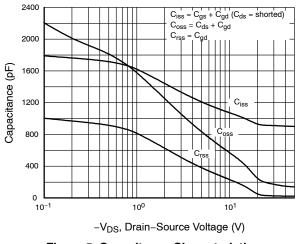
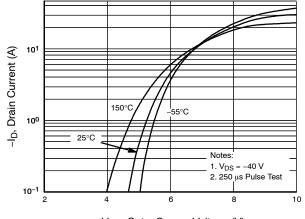


Figure 5. Capacitance Characteristics



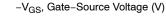


Figure 2. Transfer Characteristics

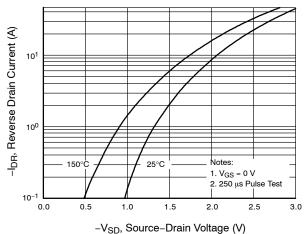


Figure 4. Body Diode Forward Voltage

Variation vs. Source Current and Temperature

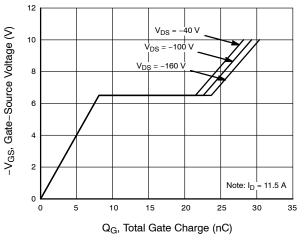


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS (continued)

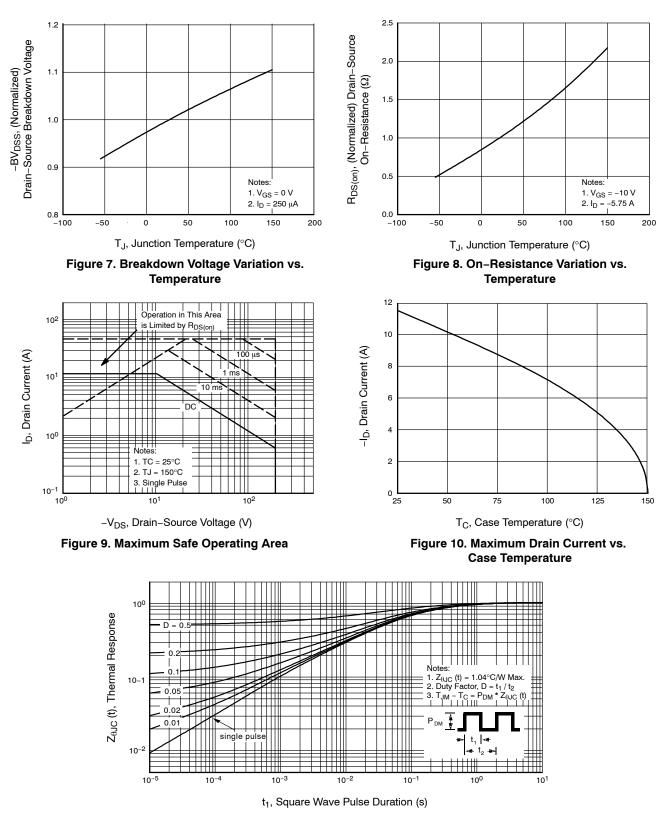


Figure 11. Capacitance Characteristics

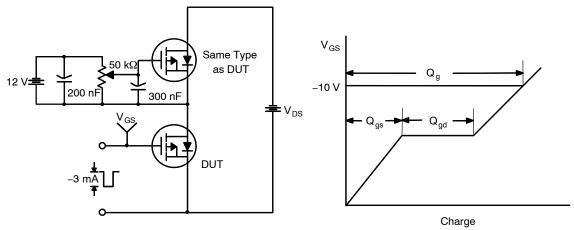


Figure 12. Gate Charge Test Circuit & Waveform

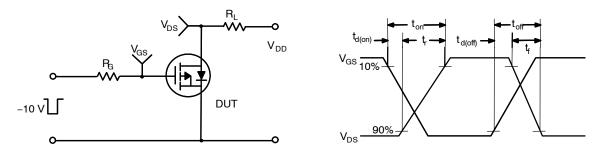


Figure 13. Resistive Switching Test Circuit & Waveforms

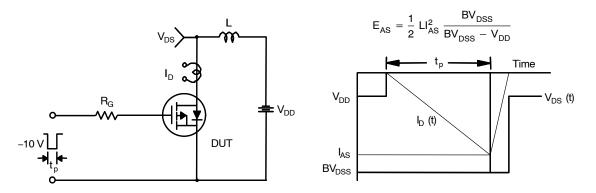


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

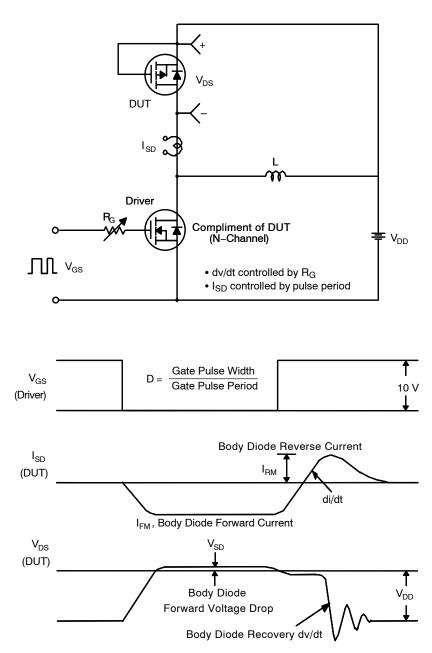


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

PACKAGE MARKING AND ORDERING INFORMATION

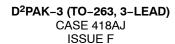
Device	Marking	Package	Reel Size	Tape Width	Shipping [†]
FQB12P20TM	FQB12P20	D ² PAK (Pb–Free)	330 mm	24 mm	800 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

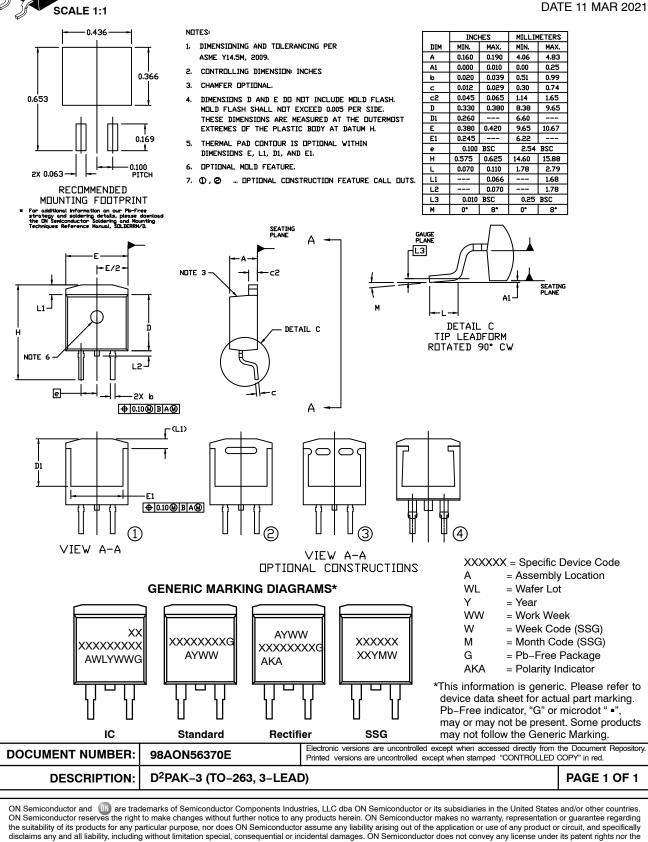
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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS









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